

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

INADA et al

International Appln. No.: PCT/JP2003/014572

Filed: Concurrently herewith

Attorney Dkt. No.: 59559.00020

For: MOLD FOR MOLDING, MOLDING METHOD, DISC SUBSTRATE, AND  
MOLDING MACHINE

**PRELIMINARY AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

May 11, 2005

Sir:

Prior to calculation of the filing fees and initial examination of the application,  
please amend the above-identified application as set forth below.

**Amendments to the claims are submitted on page 2.**

**Remarks are submitted on page 6.**